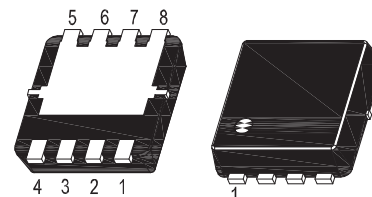
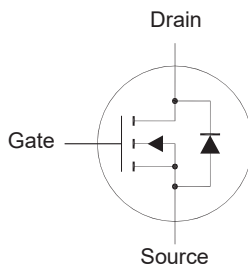


N-Channel Enhancement Mode MOSFET

Features

- AEC-Q101 Qualified
- Surface-mounted package
- Low Gate-Source Threshold Voltage
- Halogen and Antimony Free(HAF)
RoHS compliant



1. Source 2. Source 3. Source 4. Gate
5. Drain 6. Drain 7. Drain 8. Drain
DFN3030 Plastic Package

Key Parameters

Parameter	Value	Unit
BV_{DSS}	40	V
$R_{DS(ON)} \text{ Max}$	6.5 @ $V_{GS} = 10 \text{ V}$	$m\Omega$
	9 @ $V_{GS} = 4.5 \text{ V}$	
$V_{GS(th)} \text{ typ}$	1.6	V
$Q_g \text{ typ}$	69.9 @ $V_{GS} = 10 \text{ V}$	nC

Absolute Maximum Ratings (at $T_a = 25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current - Continuous	I_D	52	A
		32	
	$T_c = 25^\circ\text{C}$		
	$T_c = 100^\circ\text{C}$		
Drain Current Pulsed ¹⁾	I_{DM}	220	A
Avalanche Current	I_{AS}	20.3	A
Single Pulse Avalanche Energy ²⁾	E_{AS}	103	mJ
Power Dissipation	P_{tot}	30	W
		$T_c = 25^\circ\text{C}$	
Operating Junction and Storage Temperature Range	T_j, T_{stg}	- 55 to + 175	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Case	$R_{\theta JC}$	5	$^\circ\text{C/W}$
Thermal Resistance from Junction to Ambient ³⁾	$R_{\theta JA}$	58	$^\circ\text{C/W}$

¹⁾ Pulse Test: Pulse Width $\leq 100 \mu\text{s}$, Duty Cycle $\leq 2\%$, Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 175^\circ\text{C}$.

²⁾ Limited by $T_{J(MAX)}$, starting $T_j = 25^\circ\text{C}$, $L = 0.5 \text{ mH}$, $R_g = 25 \Omega$, $I_{AS} = 20.3 \text{ A}$, $V_{GS} = 10 \text{ V}$.

³⁾ Device Surface Mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate, in a still air.

Characteristics at $T_a = 25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit
STATIC PARAMETERS					
Drain-Source Breakdown Voltage at $I_D = 1\text{ mA}$	BV_{DSS}	40	-	-	V
Drain-Source Leakage Current at $V_{DS} = 32\text{ V}$	I_{DSS}	-	-	1	μA
Gate-Source Leakage Current at $V_{GS} = \pm 20\text{ V}$	I_{GSS}	-	-	± 100	nA
Gate-Source Threshold Voltage at $V_{DS} = V_{GS}$, $I_D = 250\text{ }\mu\text{A}$	$V_{GS(th)}$	1	-	2.5	V
Drain-Source On-State Resistance at $V_{GS} = 10\text{ V}$, $I_D = 10\text{ A}$ at $V_{GS} = 4.5\text{ V}$, $I_D = 5\text{ A}$	$R_{DS(on)}$	- -	- -	6.5 9	m Ω
DYNAMIC PARAMETERS					
Forward Transconductance at $V_{DS} = 5\text{ V}$, $I_D = 5\text{ A}$	g_{fs}	-	18.8	-	S
Gate resistance at $V_{GS} = 0\text{ V}$, $V_{DS} = 0\text{ V}$, $f = 1\text{ MHz}$	R_g	-	0.5	-	Ω
Input Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 20\text{ V}$, $f = 1\text{ MHz}$	C_{iss}	-	3255	-	pF
Output Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 20\text{ V}$, $f = 1\text{ MHz}$	C_{oss}	-	260	-	pF
Reverse Transfer Capacitance at $V_{GS} = 0\text{ V}$, $V_{DS} = 20\text{ V}$, $f = 1\text{ MHz}$	C_{rss}	-	195	-	pF
Gate charge total at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$ at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 4.5\text{ V}$	Q_g	- -	69.9 33	- -	nC
Gate to Source Charge at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$	Q_{gs}	-	10	-	nC
Gate to Drain Charge at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$	Q_{gd}	-	13	-	nC
Turn-On Delay Time at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$, $R_g = 3.3\text{ }\Omega$	$t_{d(on)}$	-	22	-	ns
Turn-On Rise Time at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$, $R_g = 3.3\text{ }\Omega$	t_r	-	26	-	ns
Turn-Off Delay Time at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$, $R_g = 3.3\text{ }\Omega$	$t_{d(off)}$	-	21	-	ns
Turn-Off Fall Time at $V_{DS} = 20\text{ V}$, $I_D = 10\text{ A}$, $V_{GS} = 10\text{ V}$, $R_g = 3.3\text{ }\Omega$	t_f	-	3	-	ns
Body-Diode PARAMETERS					
Drain-Source Diode Forward Voltage at $I_S = 1\text{ A}$, $V_{GS} = 0\text{ V}$	V_{SD}	-	-	1.2	V
Body-Diode Continuous Current	I_S	-	-	52	A
Body-Diode Continuous Current, Pulsed	I_{SM}	-	-	220	A
Body Diode Reverse Recovery Time at $I_S = 10\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$	t_{rr}	-	16	-	ns
Body Diode Reverse Recovery Charge at $I_S = 10\text{ A}$, $di/dt = 100\text{ A}/\mu\text{s}$	Q_{rr}	-	9	-	nC

Fig. 1 Typical Output Characteristics

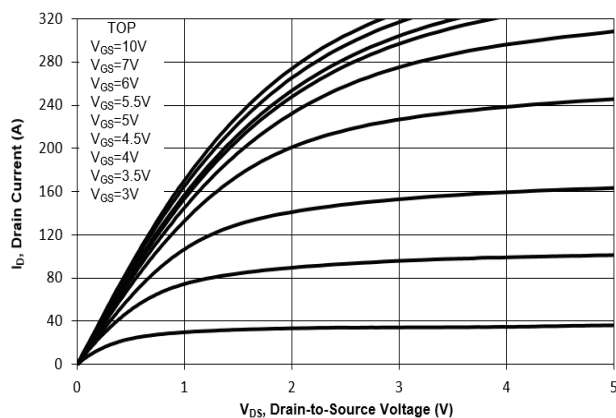


Fig. 2 Typical Transfer Characteristics

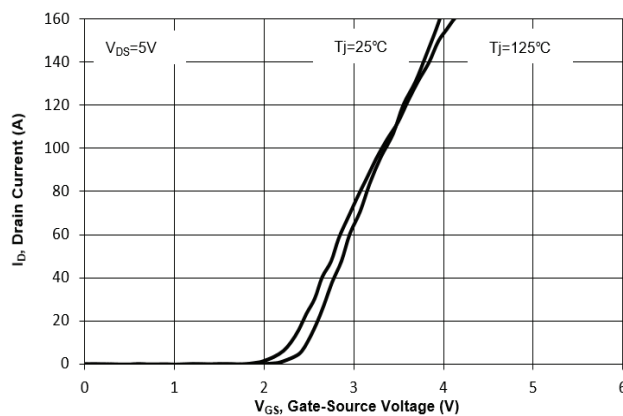


Fig. 3 On-Resistance vs. Drain Current

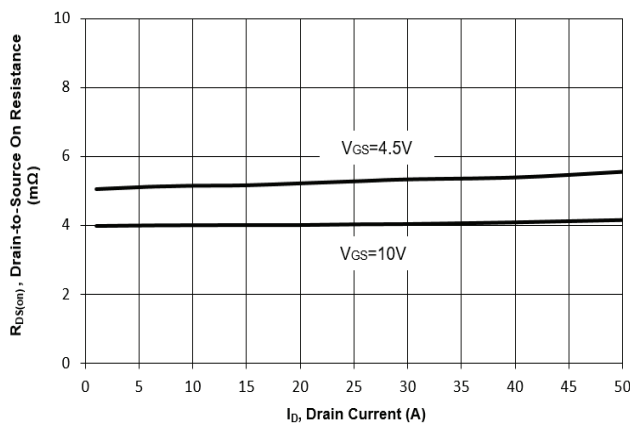


Fig. 4 On-Resistance vs. Gate to Source Voltage

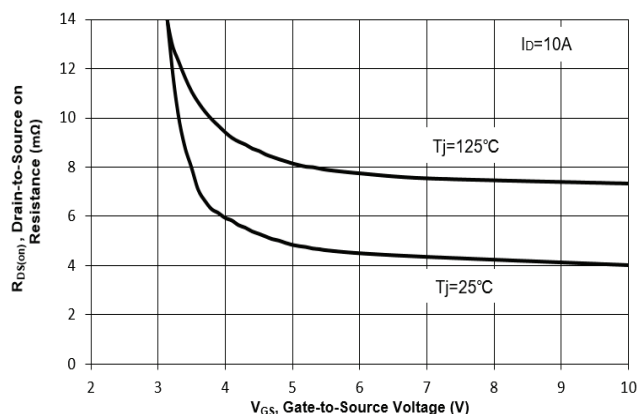


Fig. 5 On-Resistance vs. T_J

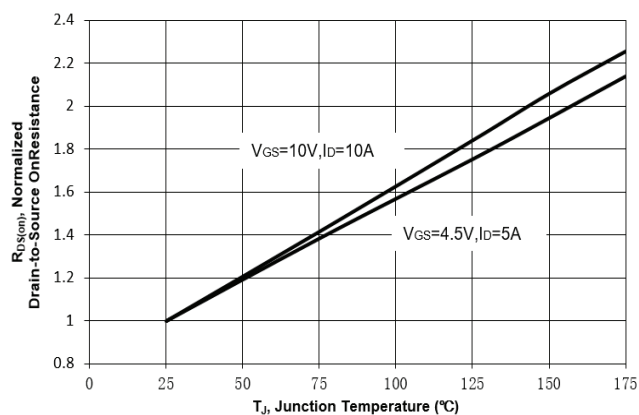
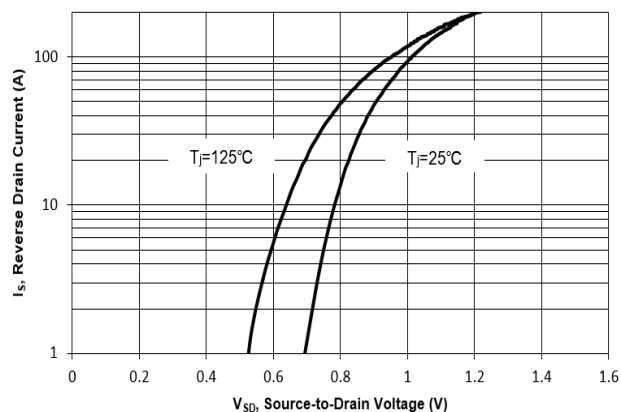


Fig. 6 Typical Body-Diode Forward Characteristics



Electrical Characteristics Curves

Fig. 7 Typical Junction Capacitance

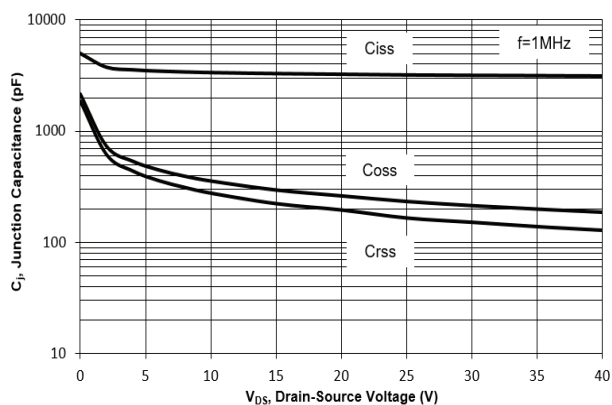


Fig. 8 Drain-Source Leakage Current vs. T_J

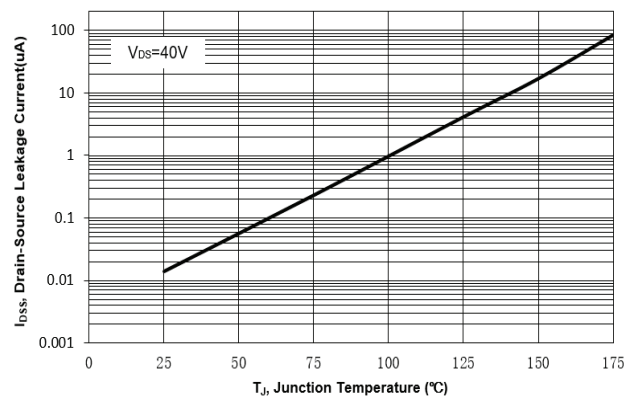


Fig. 9 $V_{(BR)DSS}$ vs. Junction Temperature

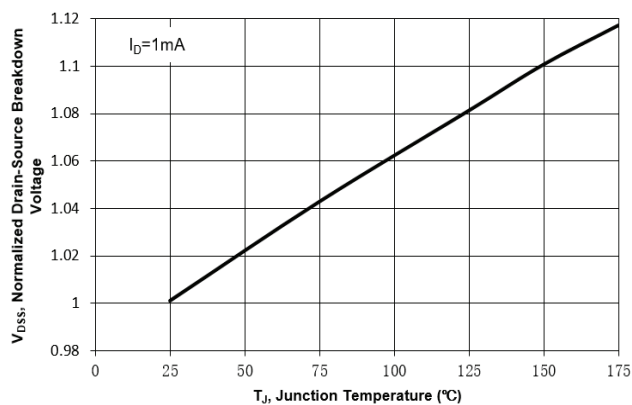


Fig. 10 Gate Threshold Variation vs. T_J

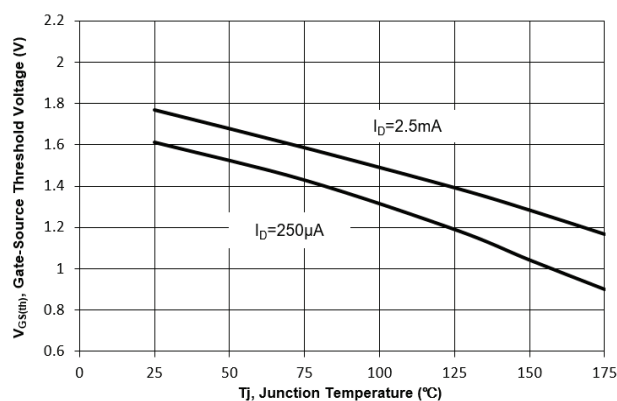


Fig. 11 Gate Charge

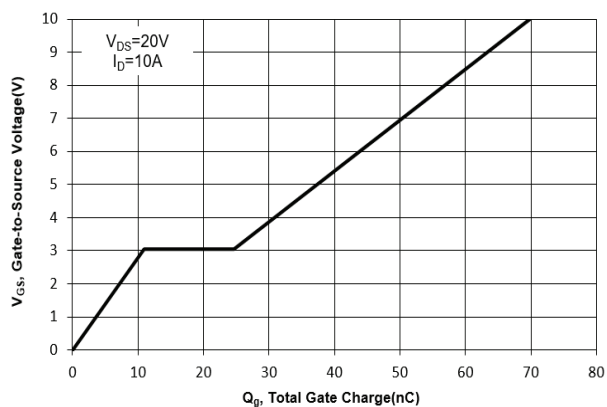
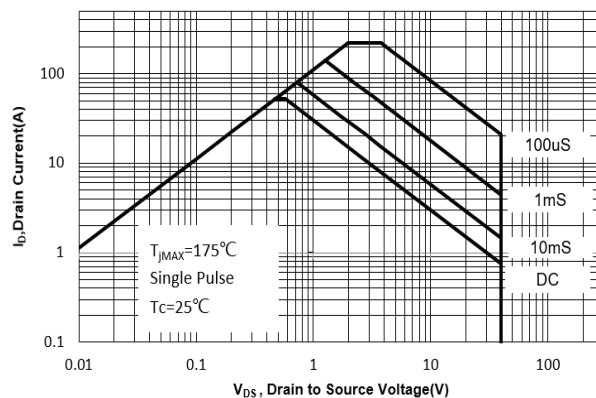


Fig. 12 Safe Operation Area



Electrical Characteristics Curves

Fig.13 Normalized Maximum Transient Thermal Impedance($Z_{\theta JC}$)

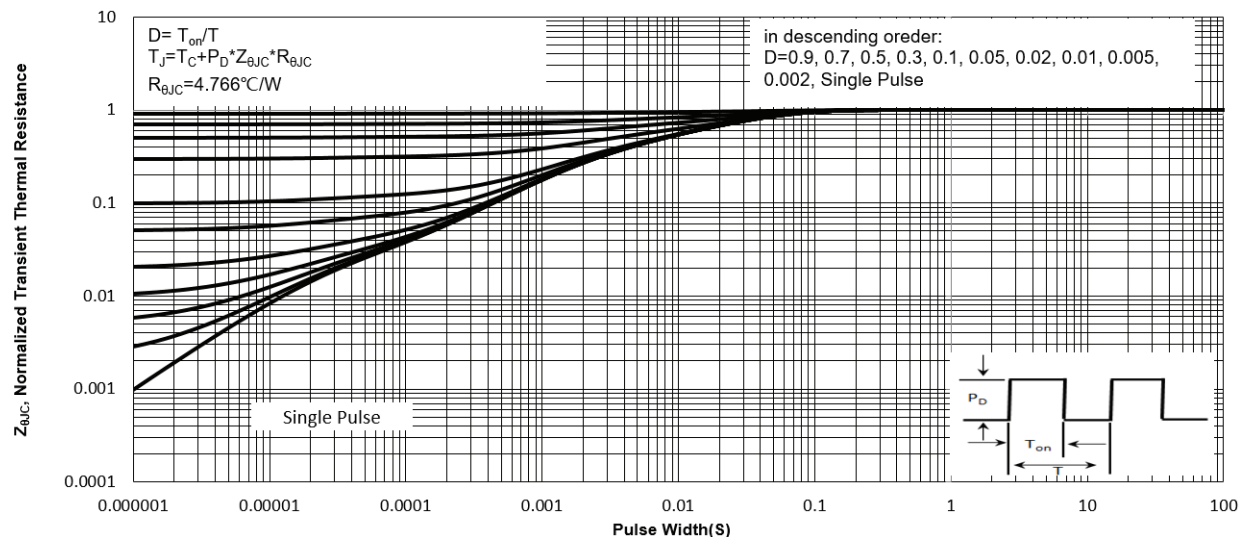
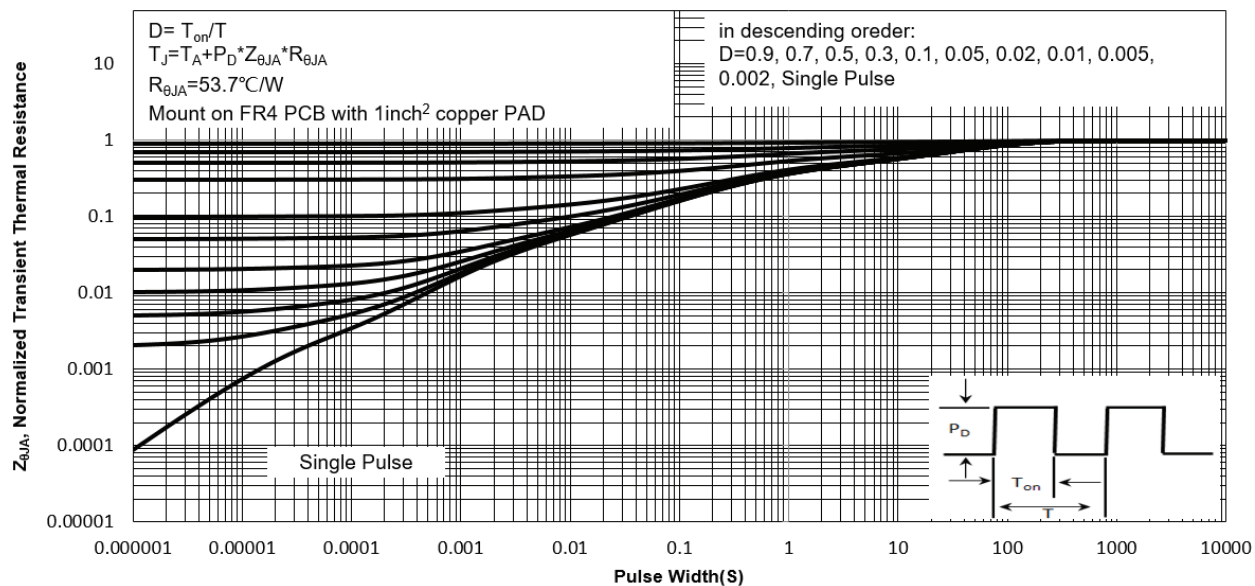


Fig.14 Normalized Maximum Transient Thermal Impedance($Z_{\theta JA}$)



Test Circuits

Fig.1-1 Switching times test circuit

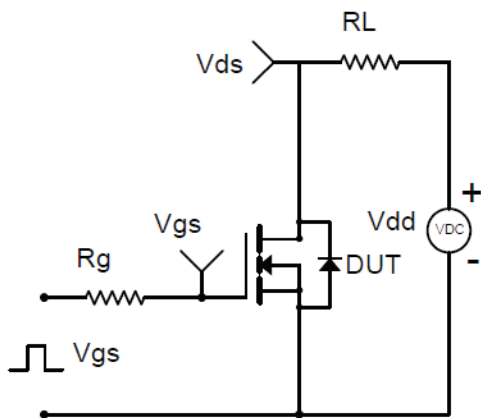


Fig.1-2 Switching Waveform

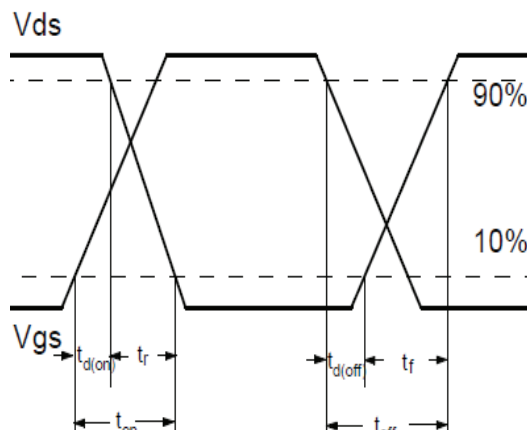


Fig.2-1 Gate charge test circuit

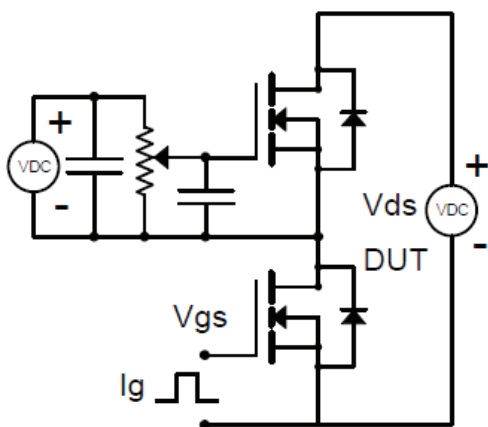


Fig.2-2 Gate charge waveform

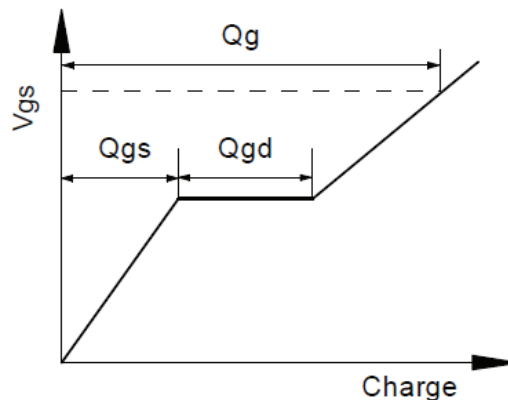


Fig.3-1 Avalanche test circuit

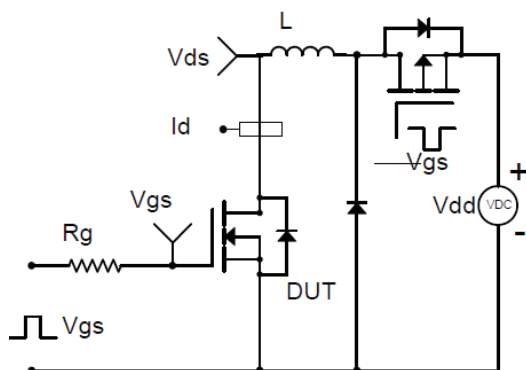
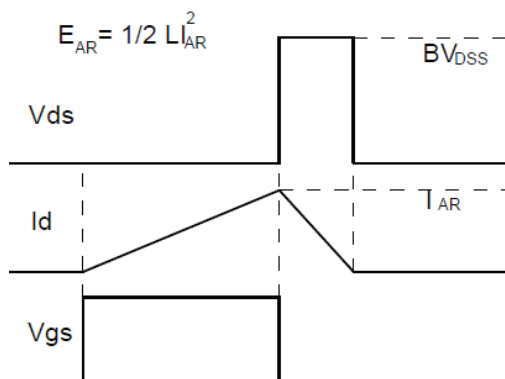
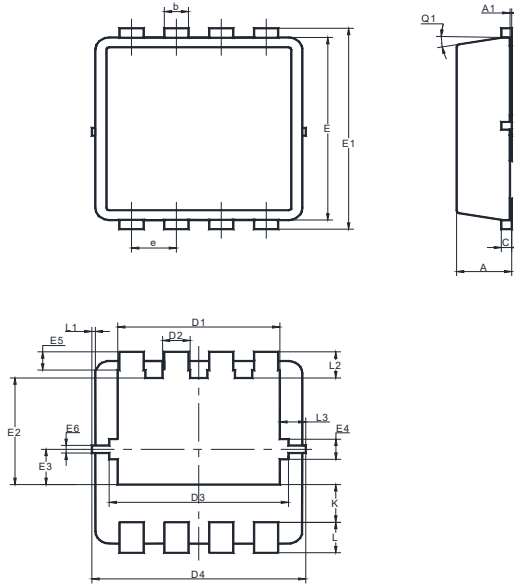


Fig.3-2 Avalanche waveform



Package Outline Dimensions (Units: mm)

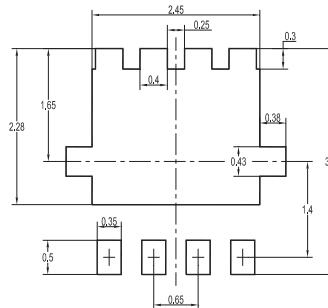
DFN3030



UNIT	A	A1	b	c	D1	D2	D3	D4	E	E1	E2	E3	E4
mm	0.9	0.05	0.35	0.25	2.6	0.5	2.7	3.2	3.1	3.3	1.85	0.68	0.43
	0.7	0	0.24	0.1	2.4	0.3	2.5	3	2.9	3.1	1.65	0.48	0.23

UNIT	E5	E6	e	K	L	L1	L2	L3	θ1
mm	0.4	0.25	0.7	0.72	0.5	0.1	0.53	0.475	12°
	0.2	0.15	0.6	0.52	0.3	0	0.33	0.275	0°

Recommended Soldering Footprint



Packing information

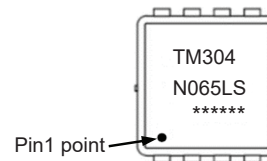
Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
DFN3030	12	8 ± 0.1	0.315 ± 0.004	330	13	5,000

Marking information

" TM304N065LS " = Part No.

" ***** " = Date Code Marking

Font type: Arial



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